BYQ30E, BYQ30EB, BYQ30ED series

FEATURES

- · Low forward volt drop
- Fast switching
- Soft recovery characteristic
- Reverse surge capability
- High thermal cycling performance
- Low thermal resistance



QUICK REFERENCE DATA



SOT428

GENERAL DESCRIPTION

Dual, ultra-fast, epitaxial rectifier diodes intended for use as output rectifiers in high frequency switched mode power supplies.

SOT404

The BYQ30E series is supplied in the SOT78 conventional leaded package. The BYQ30EB series is supplied in the SOT404 surface mounting package. The BYQ30ED series is supplied in the SOT428 surface mounting package.

PINNING

PIN DESCRIPTION	
1	anode 1
2	cathode ¹
3	anode 2
tab	cathode



tab	
$\begin{array}{c} 1 \\ 1 \\ 3 \end{array}$	



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT
		BYQ30E/ BYQ30EB/ BYQ30ED		-150	-200	
V _{RRM}	Peak repetitive reverse voltage		-	150	200	V
V_{RWM}	Working peak reverse voltage		-	150	200	V
V _R	Continuous reverse voltage		-	150	200	V
I _{O(AV)}	Average rectified output current (both diodes conducting)	square wave; δ = 0.5; T _{mb} \leq 104 °C	-	1	6	A
I _{FRM}	Repetitive peak forward current per diode	square wave; δ = 0.5; T _{mb} \leq 104 °C	-	1	6	A
I _{FSM}	Non-repetitive peak forward current per diode	t = 10 ms t = 8.3 ms sinusoidal; with reapplied V _{RRM(max)}	-		0 8	A A
I _{RRM}	Peak repetitive reverse surge current per diode	$t_p = 2 \ \mu s; \ \delta = 0.001$	-	0	.2	A
I _{RSM}	Peak non-repetitive reverse surge current per diode	$t_p = 100 \ \mu s$	-	0	.2	A
T _j	Operating junction temperature		-	1:	50	°C
T _{stg}	Storage temperature		- 40	1:	50	°C

1. It is not possible to make connection to pin 2 of the SOT428 or SOT404 packages.

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ESD LIMITING VALUE

SYMBOL	PARAMETER	ER CONDITIONS		MAX.	UNIT	
V _c	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 k Ω	-	8	kV	

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-mb} R _{th j-a}	Thermal resistance junction to mounting base Thermal resistance junction to ambient	per diode both diodes SOT78 package, in free air SOT404 and SOT428 packages, pcb mounted, minimum footprint, FR4 board		- - 60 50	3 2.5 - -	K/W K/W K/W

ELECTRICAL CHARACTERISTICS

All characteristics are per diode at $T_i = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	I _F = 8 A; T _i = 150°C	-	0.84	0.95	V
		I _F = 16 A; T _i = 150°C	-	1	1.15	V
		$I_{\rm F} = 16 {\rm A}^{-1}$	-	1.12	1.25	V
I _R	Reverse current	$V_R = V_{RWM}$	-	4	30	μΑ
		$V_R = V_{RWM}$; $T_i = 100^{\circ}C$	-	0.3	0.6	mΑ
Q _{rr}	Reverse recovered charge	$I_{\rm F} = 2 \text{ A}; V_{\rm R} \ge 30 \text{ V}; -dI_{\rm F}/dt = 20 \text{ A}/\mu\text{s}$	-	4	11	nC
t _{rr1}	Reverse recovery time	$I_{\rm F} = 1 \text{ A}; V_{\rm R} \ge 30 \text{ V}; -dI_{\rm F}/dt = 100 \text{ A}/\mu \text{s}$		20	25	ns
t _{rr2}	Reverse recovery time	$I_{\rm F} = 0.5$ A to $I_{\rm R} = 1$ A; $I_{\rm rec} = 0.25$ A	-	12	22	ns
Ů ² _{fr}	Forward recovery voltage	$I_{F} = 1 \text{ A}; \text{ d}I_{F}/\text{d}t = 10 \text{ A}/\mu s$	-	1	-	V

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Rectifier diodes ultrafast, rugged

100 Qs / nC trr / ns 1000 ΪĒ -102 IF=10A 100 10 IF=1A 10 1.0 1 ⁻ 1 10 -dIF/dt (A/us) 100 10 dIF/dt (A/us) 100 1.0 Fig.7. Maximum t_{rr} at $T_i = 25$ °C; per diode Fig.10. Maximum Q_s at $T_i = 25$ °C; per diode Transient thermal impedance, Zth j-mb (K/W) Irrm / A 10 10 11111 1111 IF=10A 1 0.1 0.1 0.01 0.001 └─ 1us 0.01 10ms 100ms 1s 10 -dIF/dt (A/us) 10us 100us 1ms 10s 100 pulse width, tp (s) Fig.8. Maximum I_{rrm} at $T_i = 25$ °C; per diode Fig.11. Transient thermal impedance; per diode; $Z_{th j-mb} = f(t_p).$ Forward current, IF (A) 20 Tj = 25℃ Tj = 150 ℃ · 15 10 _max typ 5 0 0 0.5 1.5 2 Forward voltage, VF (V) Fig.9. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_i

BYQ30E, BYQ30EB, BYQ30ED series

MECHANICAL DATA



Notes 1. Refer to mounting instructions for SOT78 (TO220) envelopes. 2. Epoxy meets UL94 V0 at 1/8".

BYQ30E, BYQ30EB, BYQ30ED series

MECHANICAL DATA



MOUNTING INSTRUCTIONS



Notes

1. Epoxy meets UL94 V0 at 1/8".

BYQ30E, BYQ30EB, BYQ30ED series

MECHANICAL DATA



MOUNTING INSTRUCTIONS



Notes

1. Plastic meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status				
Objective specification This data sheet contains target or goal specifications for product development.				
Preliminary specification This data sheet contains preliminary data; supplementary data may be published la				
Product specification	This data sheet contains final product specifications.			
Limiting values				
or more of the limiting val operation of the device at	Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.			
Application information				
Where application information is given, it is advisory and does not form part of the specification.				
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